



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of ) Examiner: F. Palo  
Shih-Pan-Yu Hsieh ) Group Unit: 3644  
Serial No.: 09/885,140 ) Response to Paper No.: 2  
Filed: June 20, 2001 )  
For: SEED SOWING METHOD & )  
MATERIALS )

Assistant Commissioner for Patents  
Washington, D.C. 20231

SIR:

**AMENDMENT AND REQUEST FOR RECONSIDERATION  
UNDER 37 C.F.R. §1.111**

In Response to the Official Action dated August 28, 2002,  
please amend the above-identified patent application as  
follows:

**In the Claims:**

1. (Amended) A method of sowing plant seeds, comprising  
the steps of:

a) providing a thin base with water-absorbing  
ability, humidity-maintaining ability, and natural decomposing  
ability, wherein said thin base comprises a plurality of  
concavities;

b) inlaying said plant seeds in said plurality of  
concavities of said thin base and covering said plant seeds  
with a securing layer; and

c) covering a cultivating material with said thin  
base, wherein each concavity has a void therein for allowing a  
radicle of a corresponding plant seed to pierce therethrough

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